

## EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
S29	400	semiconductor and (chip or die or substrate) and (package or assembly or housing or module) and @ad<"20030222" and (encapsul\$5) and ((soft or flexible or elastic) same (filler))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/11/22 07:20
S30	1349	(257/686 or 257/687).ccls. and @ad<"20030222" and (soft or flexible or elastic or elastomer or epoxy)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/11/22 07:29
S31	318	(257/787-793).ccls. and @ad<"20030222" and ((soft or flexible or elastic or elastomer or epoxy) with side)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/11/22 07:38
S34	677	(257/723).ccls. and @ad<"20030222" and (soft or flexible or elastic or elastomer or epoxy) not S33	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/11/22 12:04